

Reverse-Conducting IGBT with monolithic body diode

Features

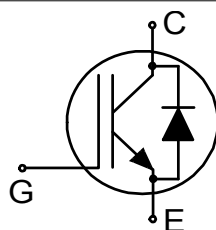
- $V_{CE} = 650\text{ V}$
- $I_C = 50\text{ A}$
- Powerful monolithic diode optimized for ZCS applications
- High ruggedness, temperature stable behavior
- Very low V_{CEsat} and low E_{off}
- Easy paralleling capability due to positive temperature coefficient in V_{CEsat}
- Low EMI
- Low electrical parameters depending (dependence) on temperature
- Qualified according to JESD-022 for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

- Welding
- PFC
- ZCS - converters



Description



Type	Package	Marking
IKW50N65WR5	PG-TO247-3	K50EWR5



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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.53	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				2.29	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		650	V
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25\text{ °C}$	80	A
			$T_c = 130\text{ °C}$	50	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			150	A
Turn-off safe operating area		$V_{CE} \leq 650\text{ V}, T_{vj} \leq 175\text{ °C}$		150	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}, D < 0.01$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	282	W
			$T_c = 100\text{ °C}$	141	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter breakdown voltage	V_{BRCES}	$I_C = 0.2 \text{ mA}$, $V_{GE} = 0 \text{ V}$		650			V
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 50 \text{ A}$, $V_{GE} = 15 \text{ V}$	$T_{vj} = 25 \text{ °C}$		1.4	1.8	V
			$T_{vj} = 175 \text{ °C}$		1.65		
Gate-emitter threshold voltage	V_{GETh}	$I_C = 0.5 \text{ mA}$, $V_{CE} = V_{GE}$		3.2	4	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 650 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$			40	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = 20 \text{ V}$				100	nA
Transconductance	g_{fs}	$I_C = 50 \text{ A}$, $V_{CE} = 20 \text{ V}$			65		S
Input capacitance	C_{ies}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1000 \text{ kHz}$			6140		pF
Output capacitance	C_{oes}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1000 \text{ kHz}$			55		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 1000 \text{ kHz}$			23		pF
Gate charge	Q_G	$V_{CC} = 520 \text{ V}$, $I_C = 50 \text{ A}$, $V_{GE} = 15 \text{ V}$			230		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 16 \text{ }\Omega$, $R_{G(off)} = 16 \text{ }\Omega$, $L_\sigma = 45 \text{ nH}$, $C_\sigma = 32 \text{ pF}$	$T_{vj} = 25 \text{ °C}$, $I_C = 25 \text{ A}$		45		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 25 \text{ A}$		43		
Rise time (inductive load)	t_r	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 16 \text{ }\Omega$, $R_{G(off)} = 16 \text{ }\Omega$, $L_\sigma = 45 \text{ nH}$, $C_\sigma = 32 \text{ pF}$	$T_{vj} = 25 \text{ °C}$, $I_C = 25 \text{ A}$		17		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 25 \text{ A}$		19		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 16 \text{ }\Omega$, $R_{G(off)} = 16 \text{ }\Omega$, $L_\sigma = 45 \text{ nH}$, $C_\sigma = 32 \text{ pF}$	$T_{vj} = 25 \text{ °C}$, $I_C = 25 \text{ A}$		417		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 25 \text{ A}$		496		
Fall time (inductive load)	t_f	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 16 \text{ }\Omega$, $R_{G(off)} = 16 \text{ }\Omega$, $L_\sigma = 45 \text{ nH}$, $C_\sigma = 32 \text{ pF}$	$T_{vj} = 25 \text{ °C}$, $I_C = 25 \text{ A}$		16		ns
			$T_{vj} = 175 \text{ °C}$, $I_C = 25 \text{ A}$		11		
Turn-on energy	E_{on}	$V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_{G(on)} = 16 \text{ }\Omega$, $R_{G(off)} = 16 \text{ }\Omega$, $L_\sigma = 45 \text{ nH}$, $C_\sigma = 32 \text{ pF}$	$T_{vj} = 25 \text{ °C}$, $I_C = 25 \text{ A}$		0.84		mJ
			$T_{vj} = 175 \text{ °C}$, $I_C = 25 \text{ A}$		1.04		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy	E_{off}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 16\ \Omega$, $R_{G(off)} = 16\ \Omega$, $L_{\sigma} = 45\text{ nH}$, $C_{\sigma} = 32\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 25\text{ A}$	0.22		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 25\text{ A}$	0.32		
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 16\ \Omega$, $R_{G(off)} = 16\ \Omega$, $L_{\sigma} = 45\text{ nH}$, $C_{\sigma} = 32\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 25\text{ A}$	1.06		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 25\text{ A}$	1.36		
Operating junction temperature	T_{vj}		-40		175	$^{\circ}\text{C}$

Note: Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	$T_c = 25\text{ }^{\circ}\text{C}$	A
			$T_c = 100\text{ }^{\circ}\text{C}$	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		150	A

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 25\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$	1.4	1.9	V
			$T_{vj} = 175\text{ }^{\circ}\text{C}$	1.5		
Diode reverse recovery time	t_{rr}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A}/\mu\text{s}$	110		ns
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A}/\mu\text{s}$	145		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	Q_{rr}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		1.8		μC
			$T_{vj} = 175\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		3.5		
Diode peak reverse recovery current	I_{rrm}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		29		A
			$T_{vj} = 175\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		39		
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		600		A/ μs
			$T_{vj} = 175\text{ °C}$, $I_F = 25\text{ A}$, $-di_F/dt = 900\text{ A/}\mu\text{s}$		1200		
Operating junction temperature	T_{vj}			-40		175	$^{\circ}\text{C}$

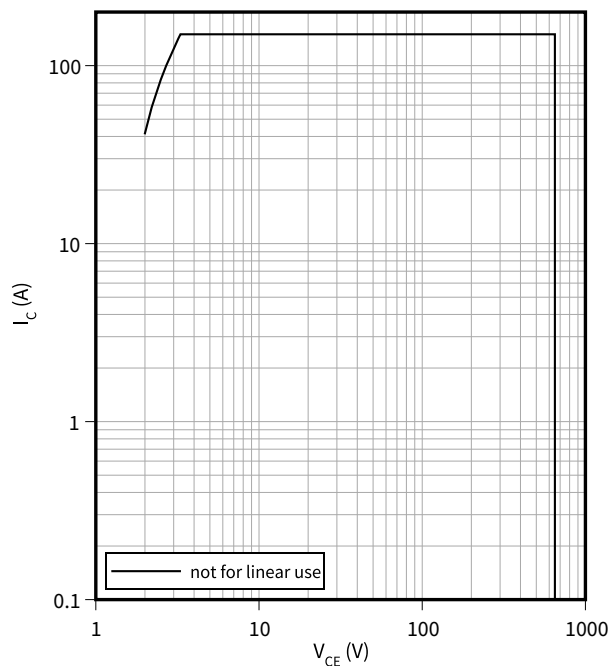
Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

Reverse bias safe operating area

$$I_C = f(V_{CE})$$

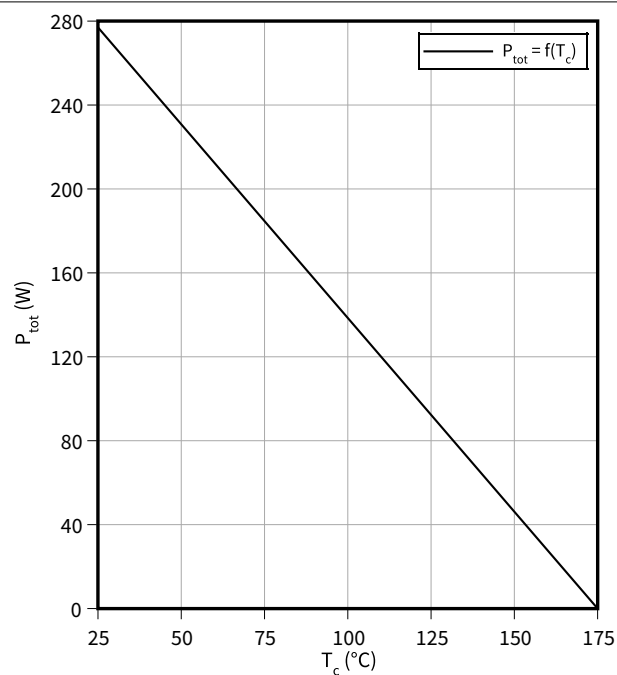
$$T_{vj} \leq 175\text{ °C}, V_{GE} = 15\text{ V}, T_c = 25\text{ °C}$$



Power dissipation as a function of case temperature

$$P_{tot} = f(T_c)$$

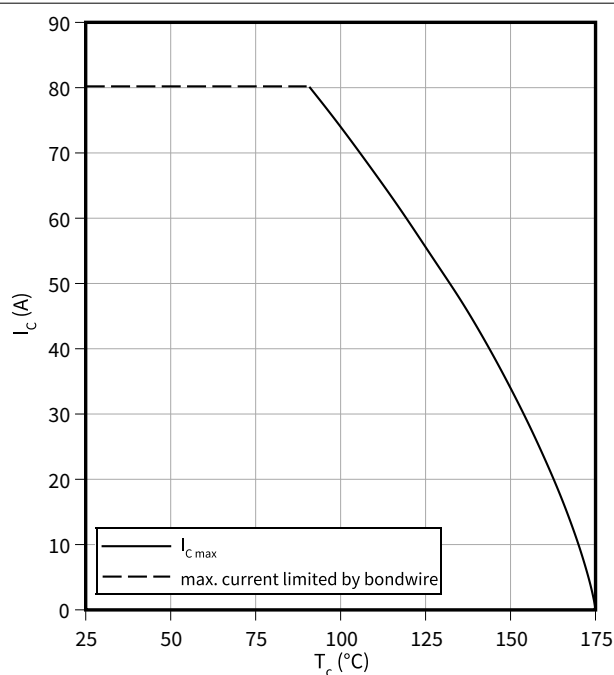
$$T_{vj} \leq 175\text{ °C}$$



Collector current as a function of case temperature

$$I_C = f(T_c)$$

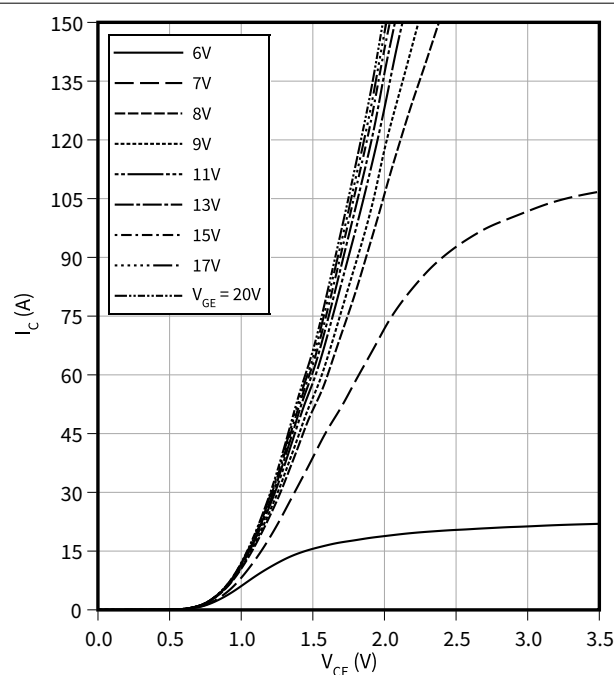
$$T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

$$T_{vj} = 25\text{ °C}$$

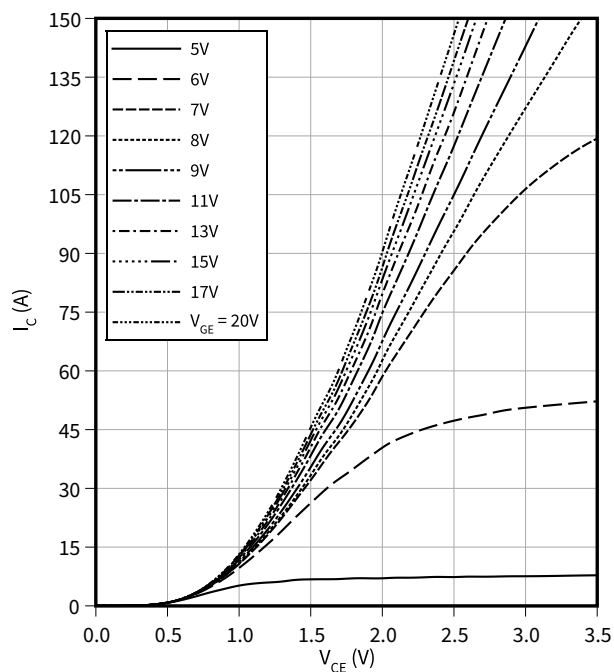


4 Characteristics diagrams

Typical output characteristic

$$I_C = f(V_{CE})$$

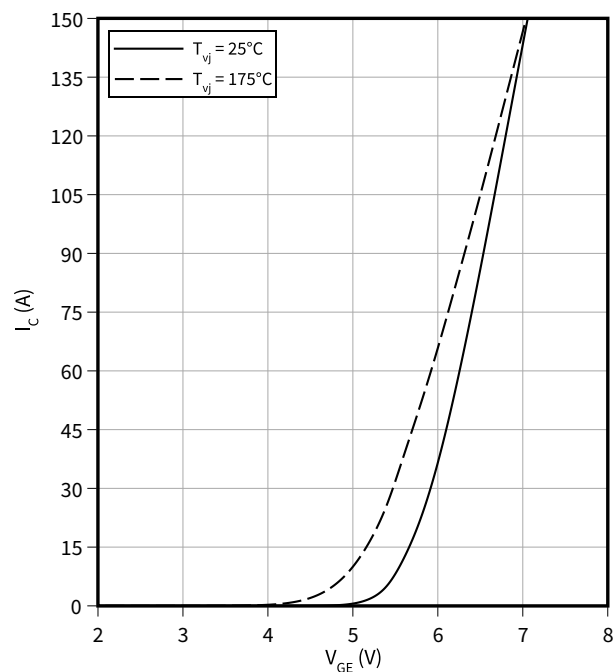
$$T_{vj} = 175\text{ }^{\circ}\text{C}$$



Typical transfer characteristic

$$I_C = f(V_{GE})$$

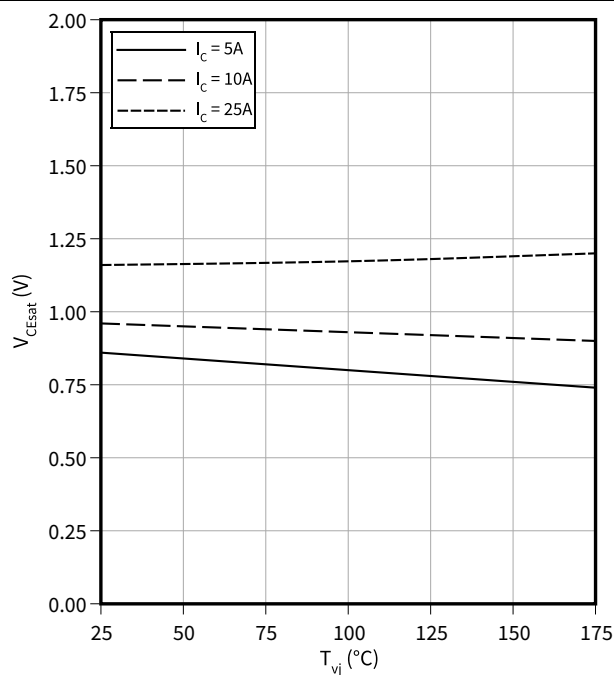
$$V_{CE} = 20\text{ V}$$



Typical collector-emitter saturation voltage as a function of junction temperature

$$V_{CEsat} = f(T_{vj})$$

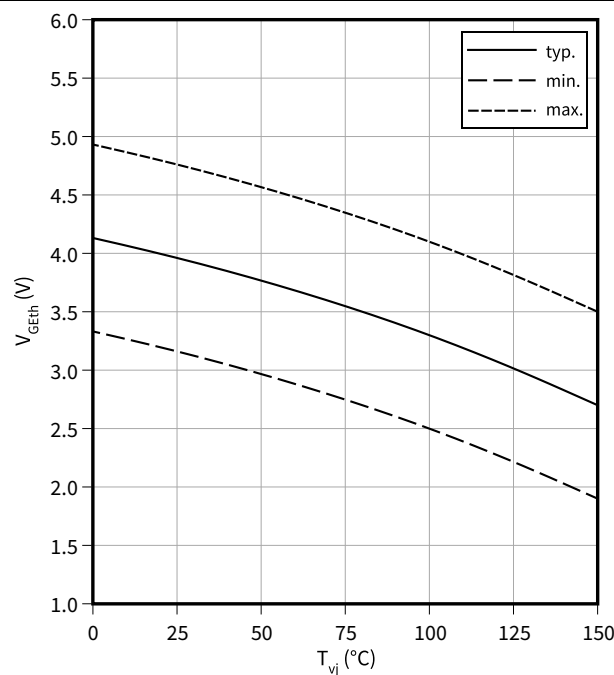
$$V_{GE} = 15\text{ V}$$



Gate-emitter threshold voltage as a function of junction temperature

$$V_{GEth} = f(T_{vj})$$

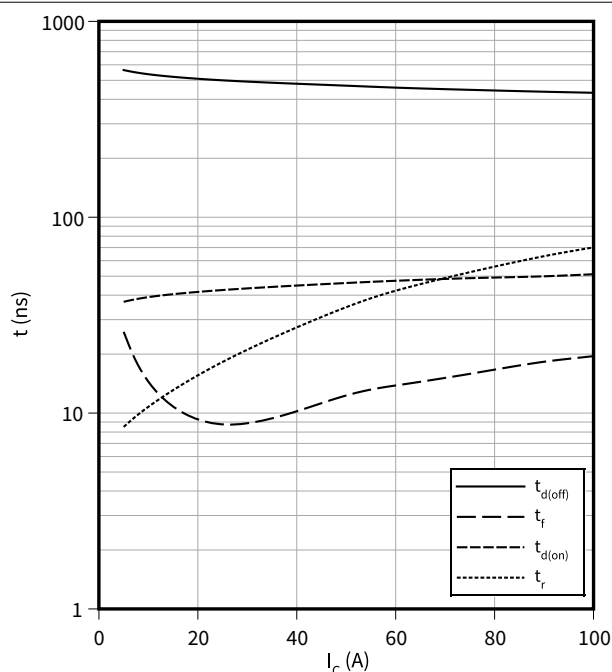
$$I_C = 0.5\text{ mA}$$



Typical switching times as a function of collector current

$$t = f(I_C)$$

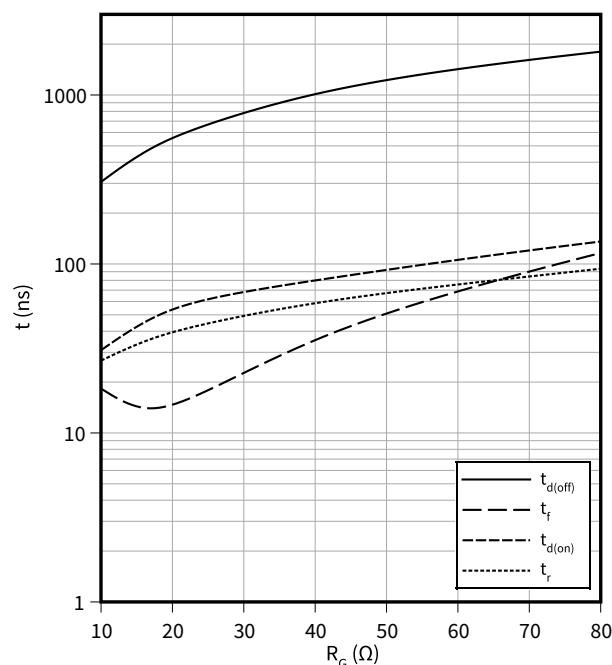
$V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ }^{\circ}\text{C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 16 \text{ } \Omega$



Typical switching times as a function of gate resistor

$$t = f(R_G)$$

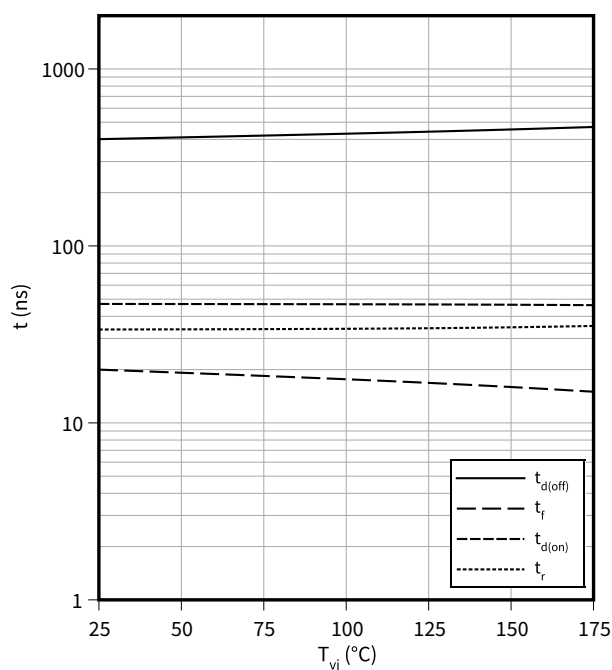
$I_C = 50 \text{ A}$, $V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ }^{\circ}\text{C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching times as a function of junction temperature

$$t = f(T_{vj})$$

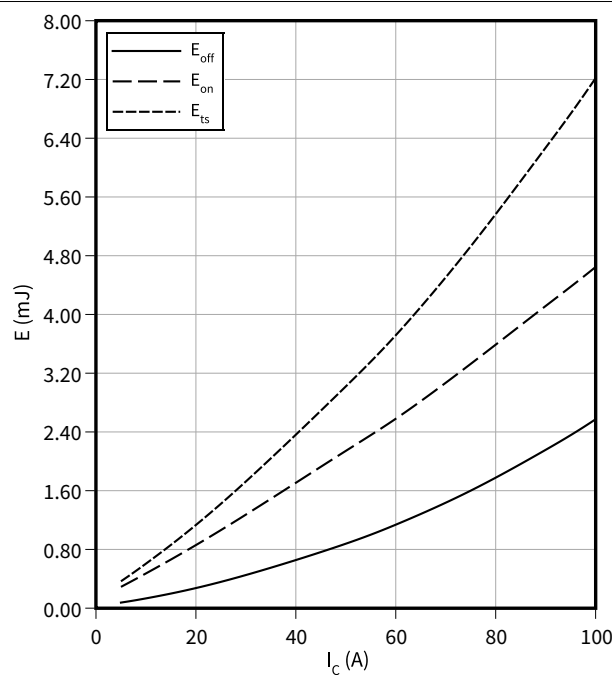
$I_C = 50 \text{ A}$, $V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 16 \text{ } \Omega$



Typical switching energy losses as a function of collector current

$$E = f(I_C)$$

$V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ }^{\circ}\text{C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 16 \text{ } \Omega$

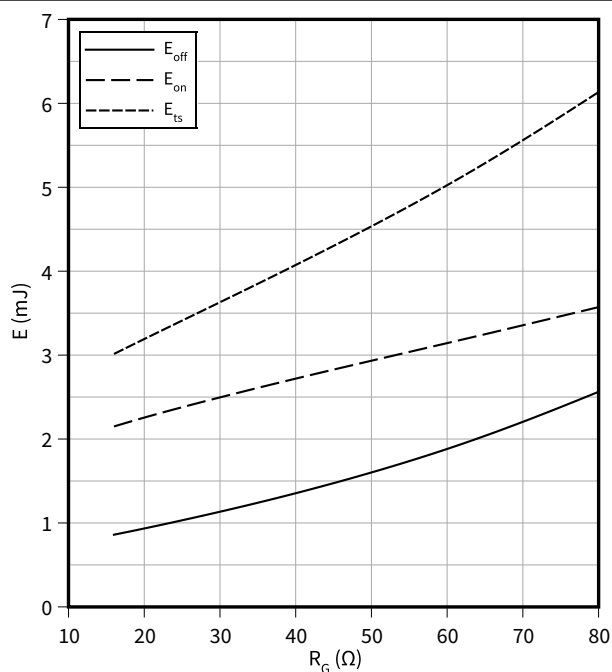


4 Characteristics diagrams

Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

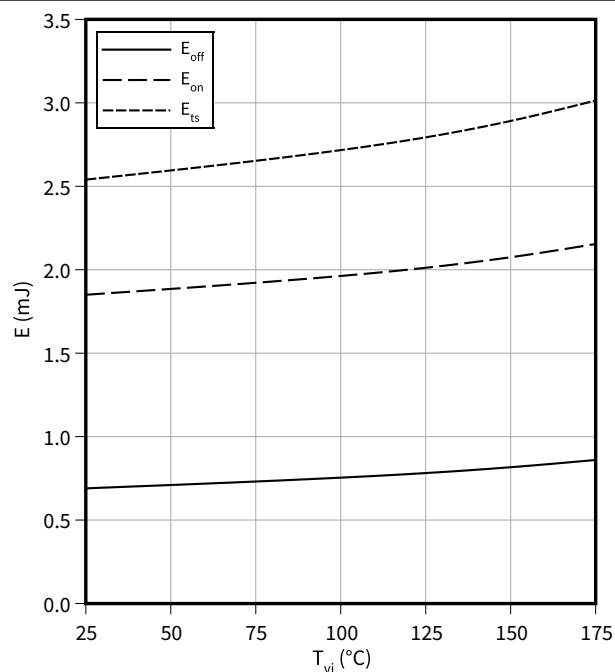
$I_C = 50 \text{ A}$, $V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching energy losses as a function of junction temperature

$$E = f(T_{vj})$$

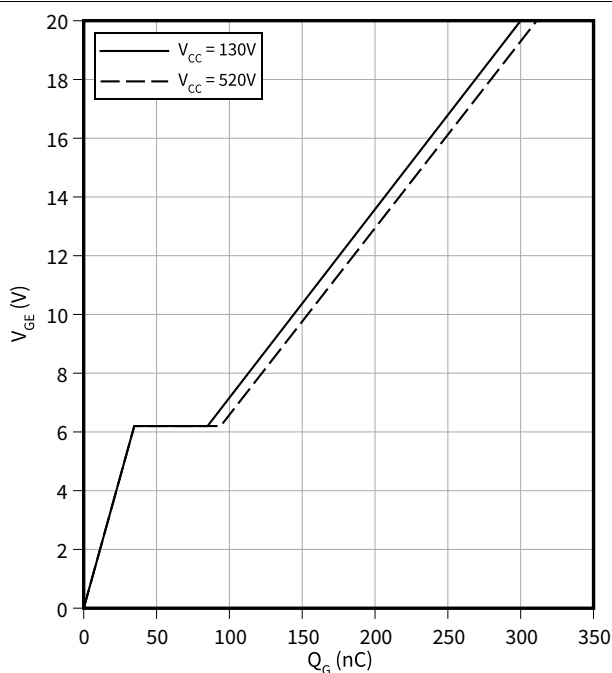
$I_C = 50 \text{ A}$, $V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 16 \text{ Ω}$



Typical gate charge

$$V_{GE} = f(Q_G)$$

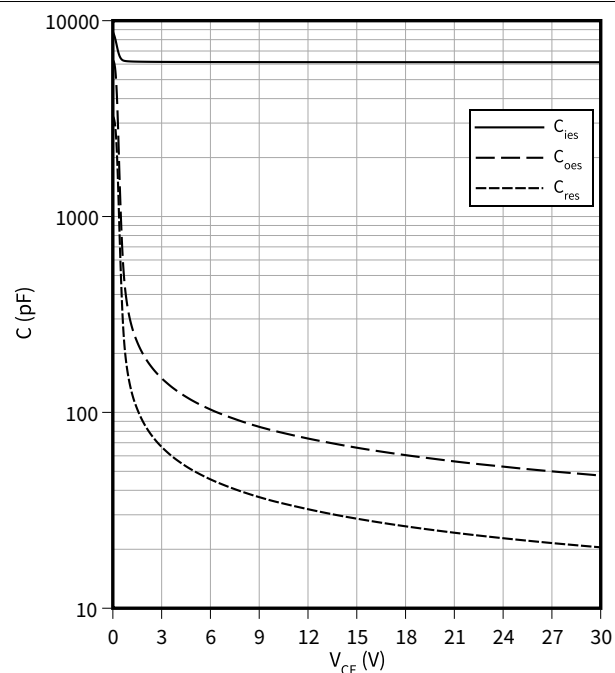
$I_C = 50 \text{ A}$



Typical capacitance as a function of collector-emitter voltage

$$C = f(V_{CE})$$

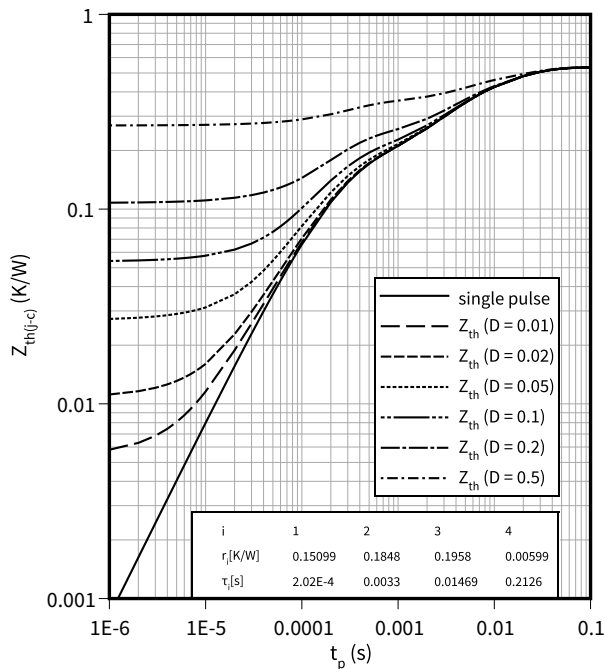
$f = 1000 \text{ kHz}$, $V_{GE} = 0 \text{ V}$



4 Characteristics diagrams

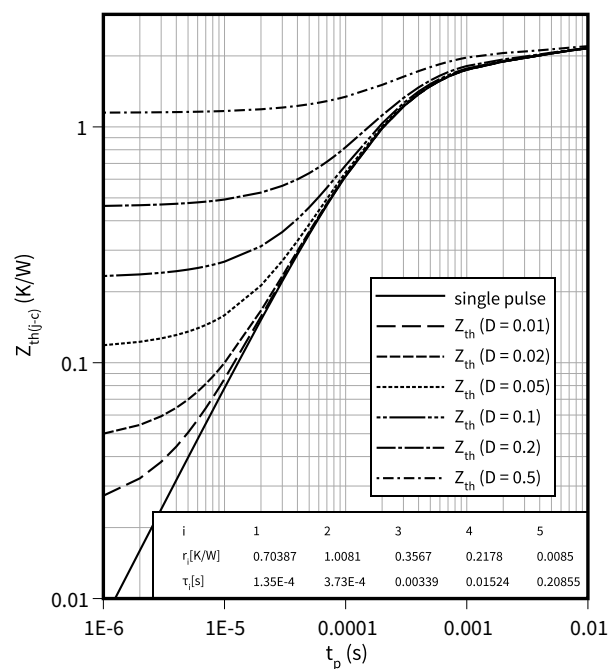
IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



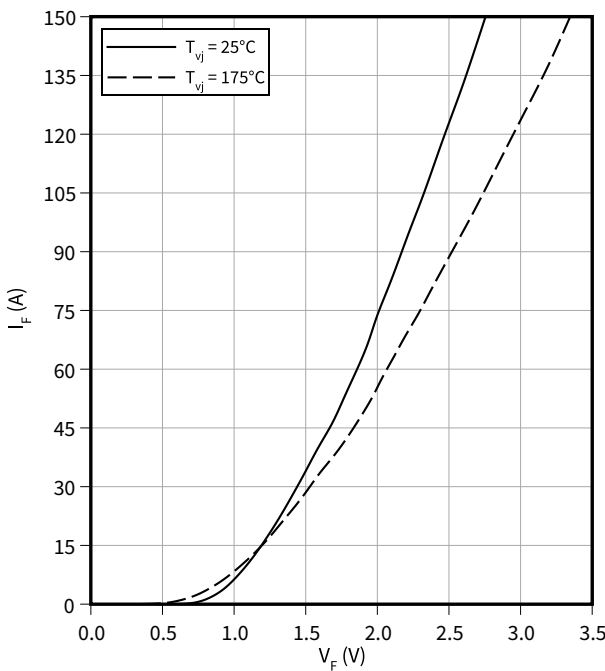
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



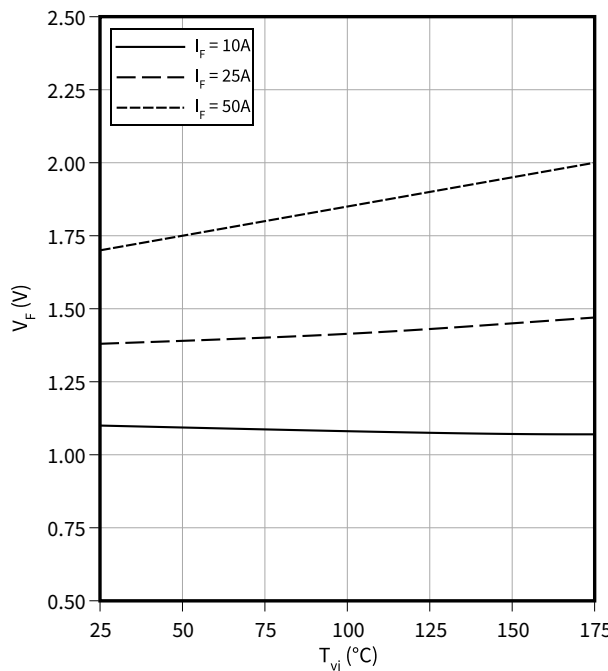
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$

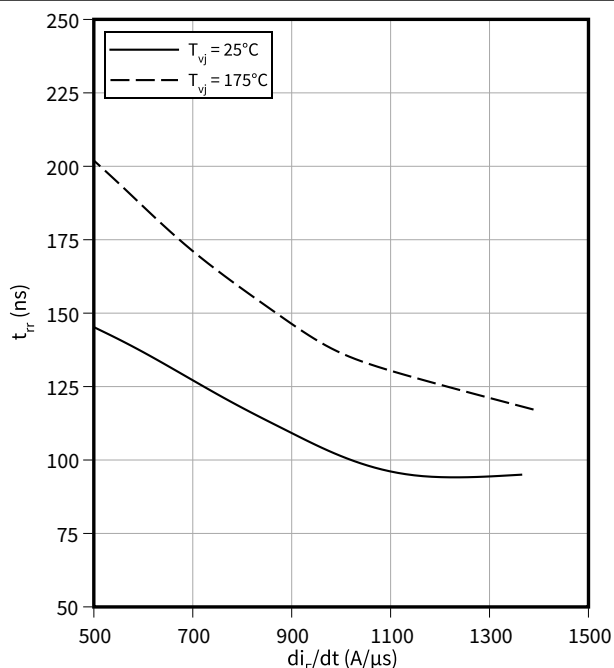


4 Characteristics diagrams

Typical reverse recovery time as a function of diode current slope

$$t_{rr} = f(di_F/dt)$$

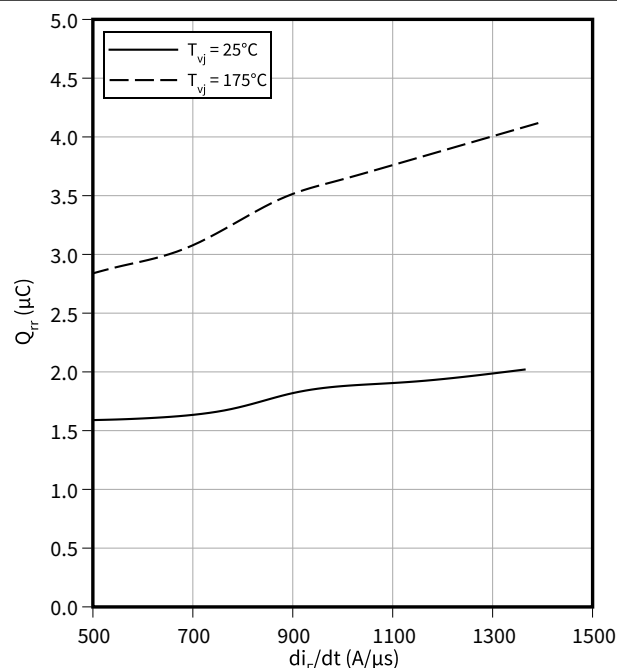
$V_R = 400 \text{ V}$, $I_F = 25 \text{ A}$



Typical reverse recovery charge as a function of diode current slope

$$Q_{rr} = f(di_F/dt)$$

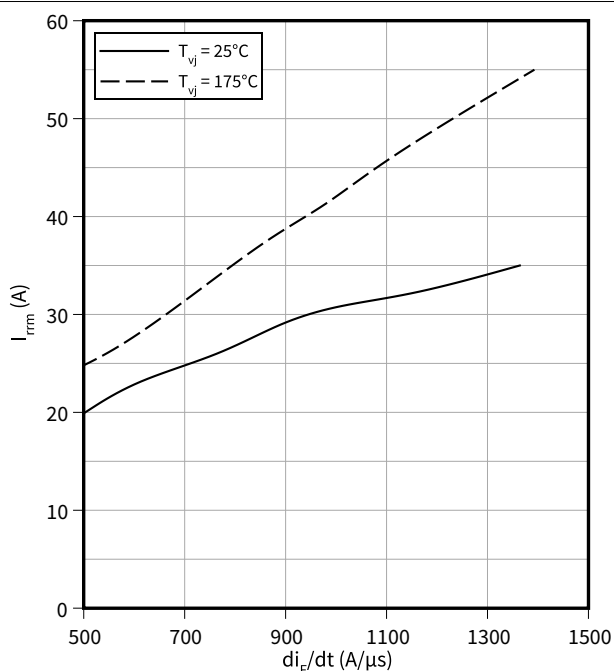
$V_R = 400 \text{ V}$, $I_F = 25 \text{ A}$



Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

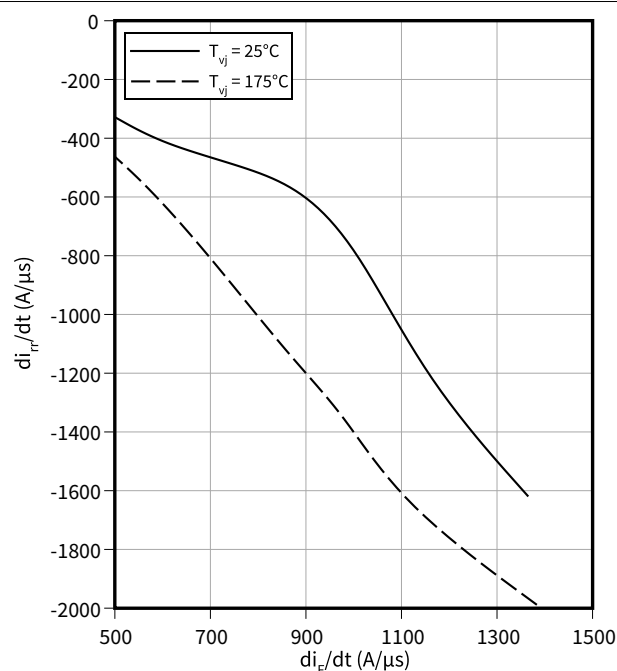
$V_R = 400 \text{ V}$, $I_F = 25 \text{ A}$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

$$di_{rr}/dt = f(di_F/dt)$$

$V_R = 400 \text{ V}$, $I_F = 25 \text{ A}$



5 Package outlines

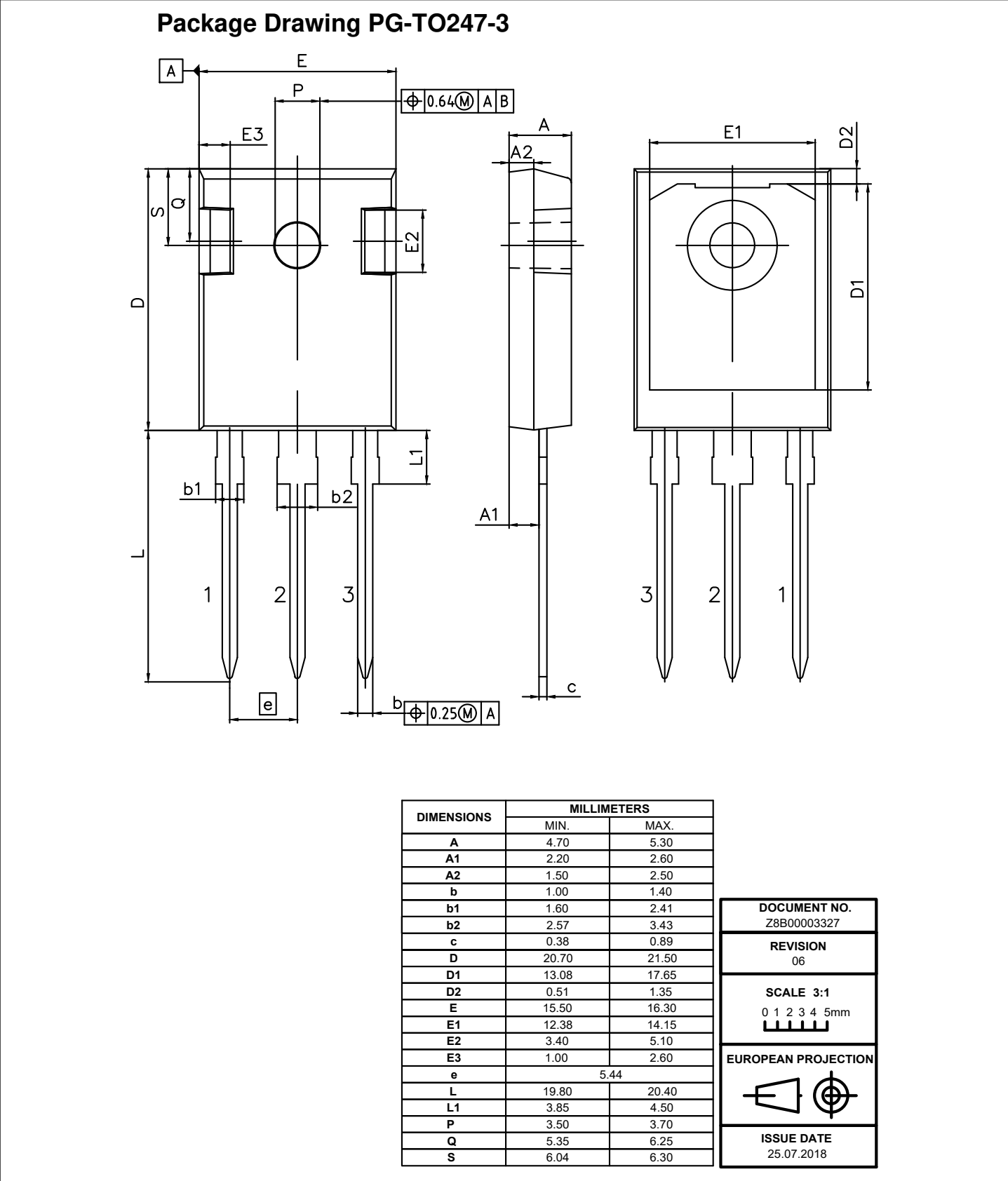


Figure 1

6 Testing conditions

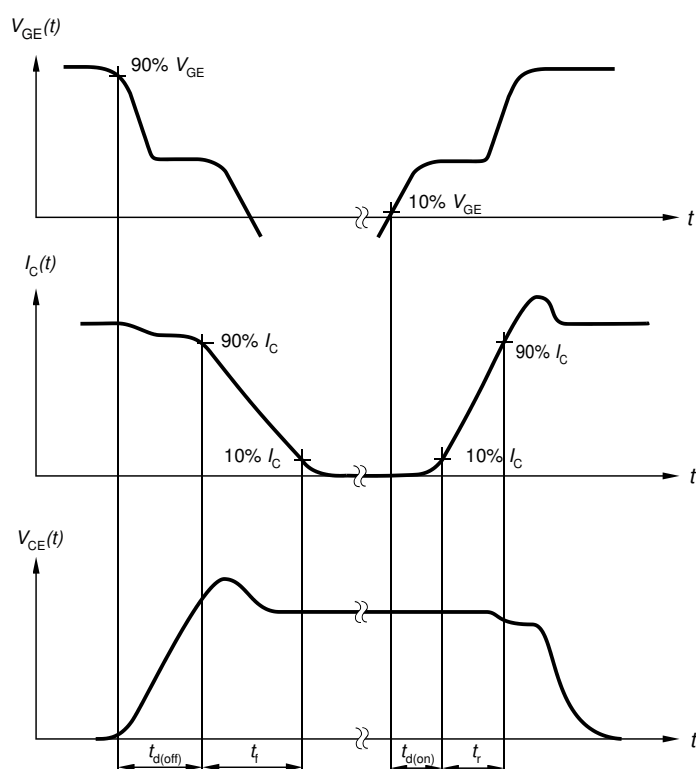


Figure A. Definition of switching times

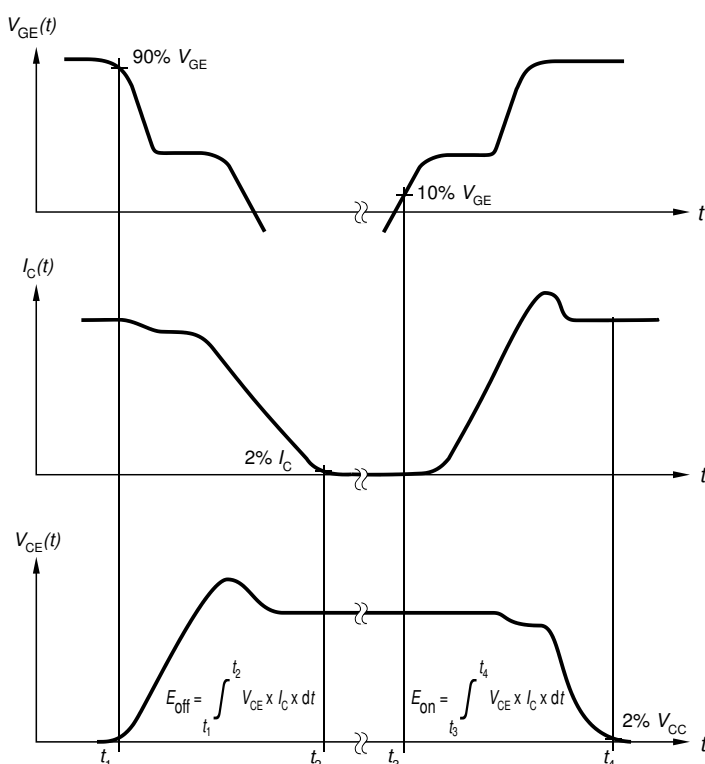


Figure B. Definition of switching losses

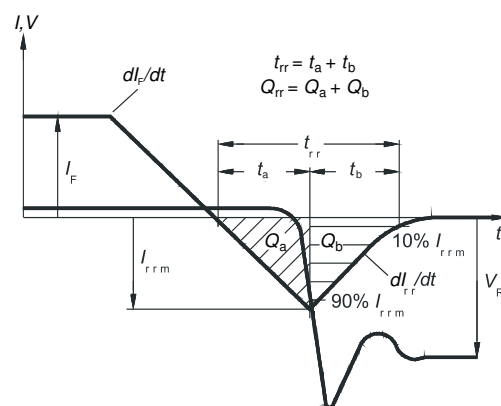


Figure C. Definition of diode switching characteristics

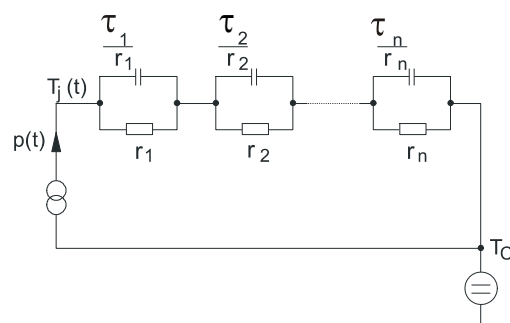


Figure D. Thermal equivalent circuit

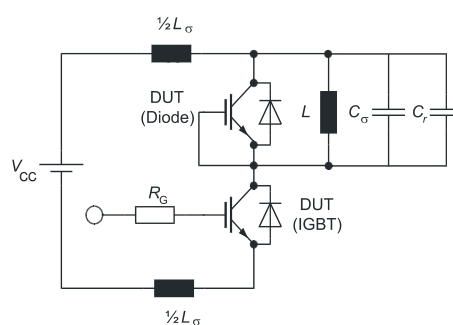


Figure E. **Dynamic test circuit**
Parasitic inductance L_σ ,
parasitic capacitor C_σ ,
relief capacitor C_r ,
(only for ZVT switching)

Revision history

Document revision	Date of release	Description of changes
V1.1	2014-12-05	Preliminary data sheet
V1.2	2015-03-27	New dynamic parameters and graphs
V1.3	2015-05-13	
V2.1	2015-12-10	Final data sheet
n/a	2020-11-30	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2022-03-08	Added transient gate-emitter voltage
1.20	2022-05-06	Transient gate-emitter voltage V_{GE} added in table “Maximum rated values” of IGBT “Forward bias safe operating area” diagram renamed to “Reverse bias safe operating area”
1.30	2023-06-13	Power dissipation conditions on page 3 updated Editorial changes

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